NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE20P85G uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} =-20V,I_D =-85A

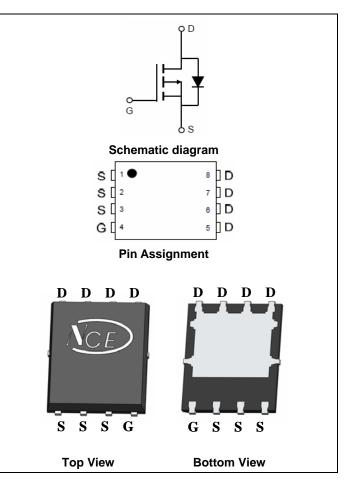
 $R_{DS(ON)}$ < 2.5m Ω @ V_{GS} =-4.5V

 $R_{DS(ON)} < 4m\Omega$ @ V_{GS} =-2.5V

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Load switch
- Battery protection



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE20P85G	NCE20P85G	DFN 5x6 -8L	-	-	-

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-20	V
Gate-Source Voltage	V _{GS}	±10	V
Drain Current-Continuous	I _D	-85	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	-49.5	Α
Pulsed Drain Current	I _{DM}	-340	Α
Maximum Power Dissipation	P _D	135	W
Derating factor		1.08	W/℃
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	$R_{ heta JC}$	0.93	°C/W



NCE20P85G

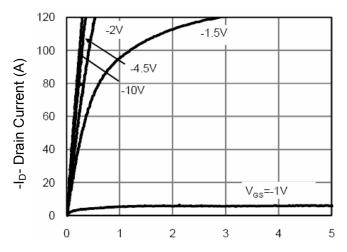
Electrical Characteristics (T_C=25 ^oC unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±10V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-0.4	-0.6	-1.0	٧
Drain-Source On-State Resistance	В	V_{GS} =-4.5V, I_{D} =-20A	-	2.0	2.5	m0
Dialii-Source Off-State Resistance	R _{DS(ON)}	V _{GS} =-2.5V, I _D =-20A	-	2.7	- V 1	
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-20A	100	-	-	S
Dynamic Characteristics (Note4)	<u> </u>					
Input Capacitance	C _{lss}	V _{DS} =-10V,V _{GS} =0V, F=1.0MHz	-	18567.5	-	PF
Output Capacitance	C _{oss}		-	1662	-	PF
Reverse Transfer Capacitance	C _{rss}		-	1432	-	V μA nA NS nS nC
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	16	-	nS
Turn-on Rise Time	t _r	V_{DD} =-10V, R_{GEN} =1 Ω	-	70	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-4.5 V , R_L =0.5 Ω	-	460	-	nS
Turn-Off Fall Time	t _f		-	240	-	nS
Total Gate Charge	Qg	\/ - 40\/ - 20 4	-	482.8	-	nC
Gate-Source Charge	Q_{gs}	F=1.0MHz V _{DD} =-10V, R _{GEN} =1Ω	-	28.5	-	nC
Gate-Drain Charge	Q_gd	v _{GS} 10 v	-	75.3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V_{GS} =0 V , I_{S} =-20 A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-85	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = -10A	-	157		nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	246	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is neg	ligible (tu	rn-on is dor	ninated by	LS+LD)

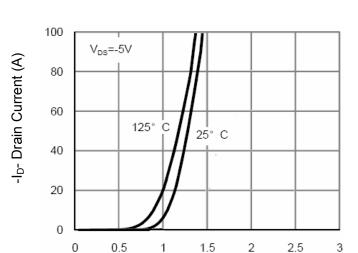
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

Typical Electrical and Thermal Characteristics (Curves)



-Vds Drain-Source Voltage (V) **Figure 1 Output Characteristics**



-Vgs Gate-Source Voltage (V)

0

Figure 2 Transfer Characteristics

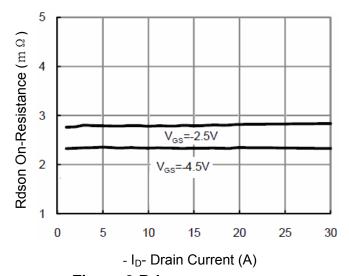


Figure 3 Rdson- Drain Current

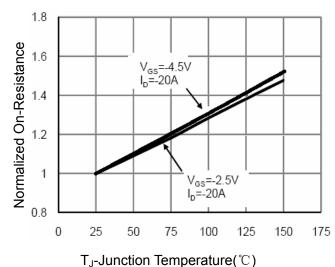


Figure 4 Rdson-Junction Temperature

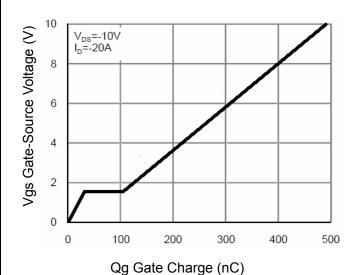


Figure 5 Gate Charge

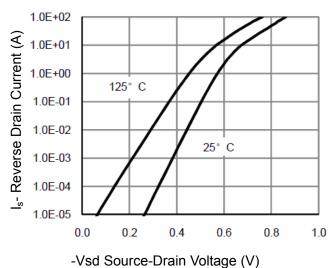


Figure 6 Source- Drain Diode Forward



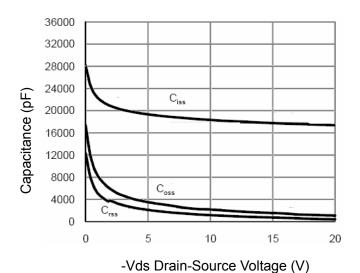
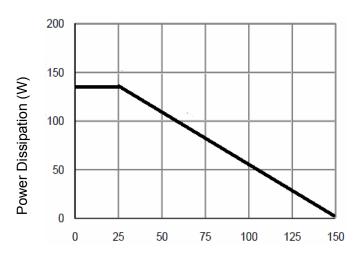


Figure 7 Capacitance vs Vds



 T_J -Junction Temperature (°C) **Figure 9 Power De-rating**

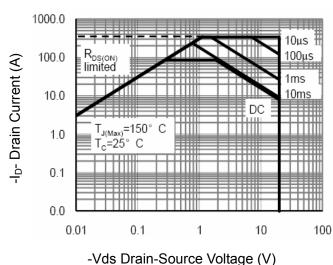
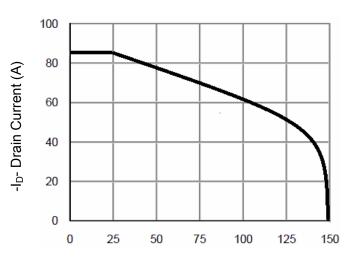


Figure 8 Safe Operation Area



 T_J -Junction Temperature (°C) Figure 10 -Current De-rating

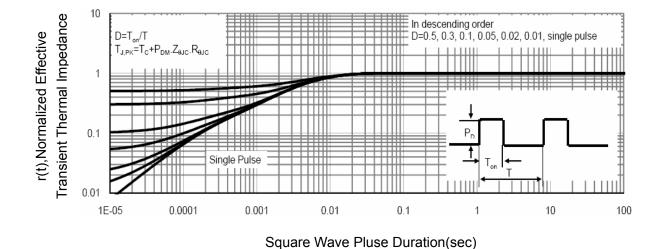
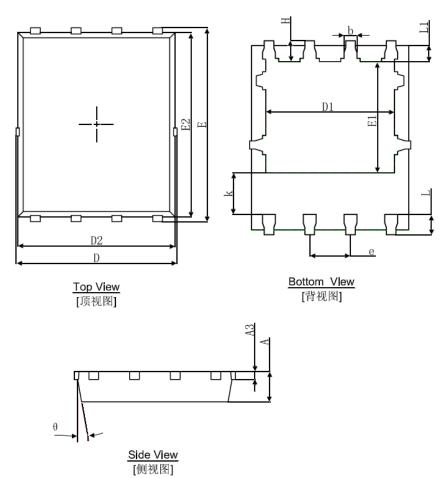


Figure 11 Normalized Maximum Transient Thermal Impedance

DFN5X6-8L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
Α	0.900	1.000	0.035	0.039		
A3	0.254	IREF.	0.010F	REF.		
D	4.944	5.096	0.195	0.201		
E	5.974	6.126	0.235	0.241		
D1	3.910	4.110	0.154	0.162		
E1	3.375	3.575	0.133	0.141		
D2	4.824	4.976	0.190	0.196		
E2	5.674	5.826	0.223	0.229		
K	1.190	1.390	0.047	0.055		
b	0.035	0.450	0.014	0.018		
е	1.270			1.270(TYP.)		ГҮР.)
L	0.559	0.711	0.022	0.028		
L1	0.424	0.576	0.017	0.023		
Н	0.574	0.726	0.023	0.029		
θ	8°	12°	8°	12°		



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NCE20P85G

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